



STS12N3LLH5

N-channel 30 V, 0.0068 Ω , 12 A, SO-8
STripFET™ V Power MOSFET

Datasheet — production data

Features

Type	V _{DSS}	R _{DS(on) max}	I _D
STS12N3LLH5	30 V	< 0.0075 Ω	12 A ⁽¹⁾

1. The value is rated according R_{thj-pcb}

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses

Application

- Switching applications

Description

This device is an N-channel Power MOSFET developed using STMicroelectronics' STripFET™V technology. The device has been optimized to achieve very low on-state resistance, contributing to an FOM that is among the best in its class.

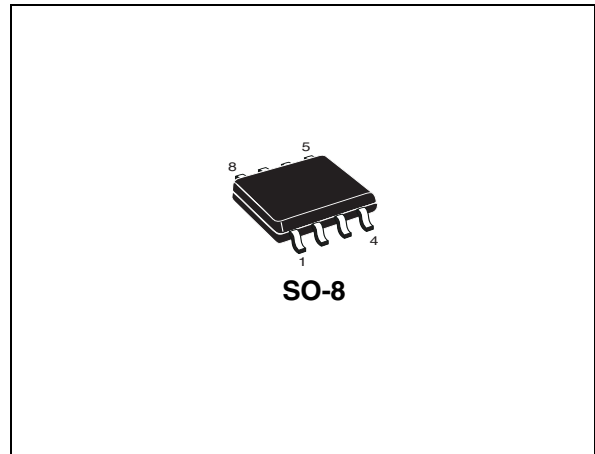


Figure 1. Internal schematic diagram

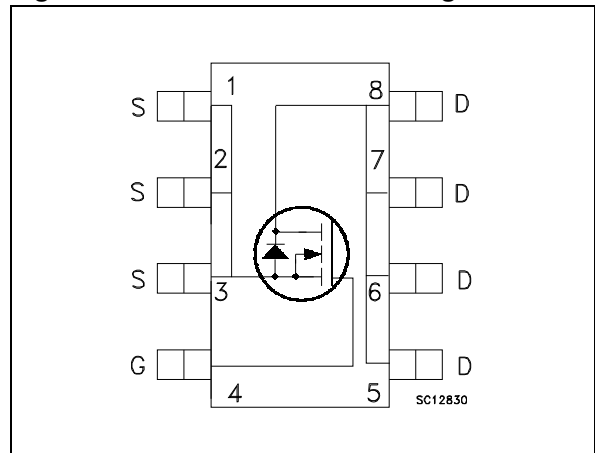


Table 1. Device summary

Order code	Marking	Package	Packaging
STS12N3LLH5	12D3L	SO-8	Tape and reel

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage ($V_{GS} = 0$)	30	V
V_{GS}	Gate-source voltage	+22/-20	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25\text{ °C}$	12	A
$I_D^{(1)}$	Drain current (continuous) at $T_C=100\text{ °C}$	8.75	A
$I_{DM}^{(2)}$	Drain current (pulsed)	48	A
$P_{TOT}^{(2)}$	Total dissipation at $T_C = 25\text{ °C}$	2.7	W
	Derating factor	0.02	W/°C
T_J	Operating junction temperature	-55 to 150	°C
T_{stg}	Storage temperature		

1. The value is rated according $R_{thj-pcb}$
2. Pulse width limited by safe operating area

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-ambient	47	°C/W

1. When mounted on FR-4 board of 1inch², 2oz Cu, $t < 10\text{sec}$

2 Electrical characteristics

($T_{CASE}=25^{\circ}C$ unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = \text{max rating},$ $V_{DS} = \text{max rating} @ 125^{\circ}C$			1 10	μA μA
I_{GSS}	Gate body leakage current ($V_{DS} = 0$)	$V_{GS} = +22/-20 V$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1			V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10 V, I_D = 6 A$ $V_{GS} = 4.5 V, I_D = 6 A$		0.0068 0.0084	0.0075 0.0092	Ω Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = 25 V, f = 1 \text{ MHz},$ $V_{GS} = 0$	-	1290		pF
C_{oss}	Output capacitance			240		pF
C_{rss}	Reverse transfer capacitance			32		pF
Q_g	Total gate charge	$V_{DD} = 15 V, I_D = 12 A$	-	8		nC
Q_{gs}	Gate-source charge	$V_{GS} = 4.5 V$		3.6		nC
Q_{gd}	Gate-drain charge	Figure 14		3.4		nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 15 V, I_D = 6 A,$ $R_G = 4.7 \Omega, V_{GS} = 10 V$ Figure 13	-	8.6		ns
t_r	Rise time			11.2		ns
$t_{d(off)}$	Turn-off delay time			32.4		ns
t_f	Fall time			6		ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Typ.	Max	Unit
I_{SD}	Source-drain current		-		12	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		48	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 12 \text{ A}, V_{GS} = 0$	-		1.1	V
t_{rr}	Reverse recovery time	$I_{SD} = 12 \text{ A},$ $di/dt = 100 \text{ A}/\mu\text{s},$ $V_{DD} = 25 \text{ V}, T_J = 150 \text{ }^\circ\text{C}$	-	22		ns
Q_{rr}	Reverse recovery charge			15		nC
I_{RRM}	Reverse recovery current			1.4		A

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration=300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

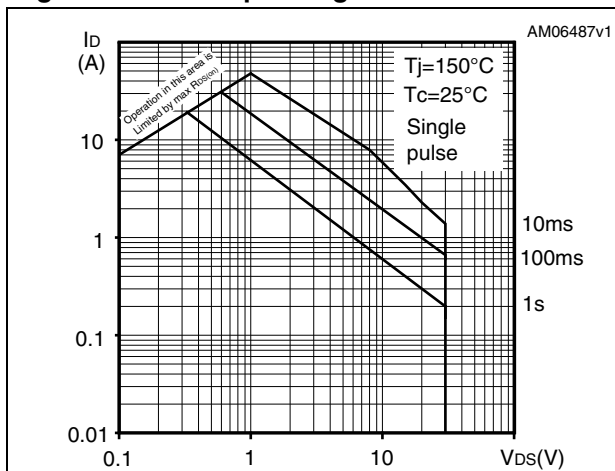


Figure 3. Thermal impedance

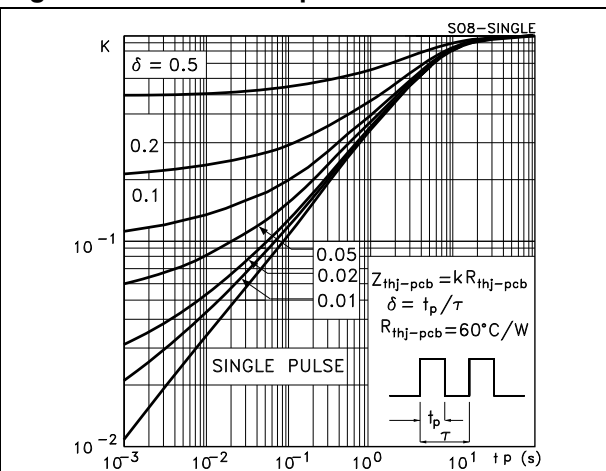


Figure 4. Output characteristics

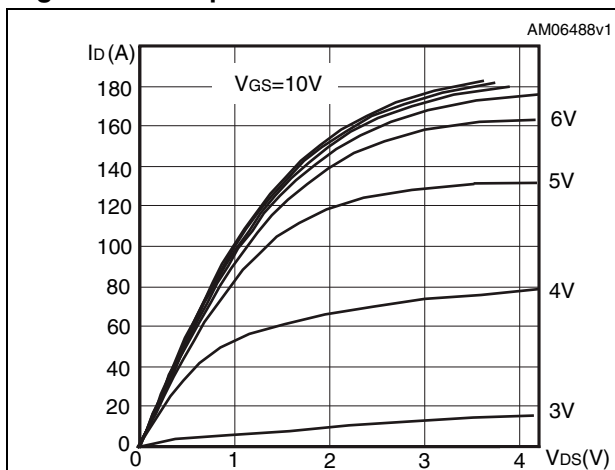


Figure 5. Transfer characteristics

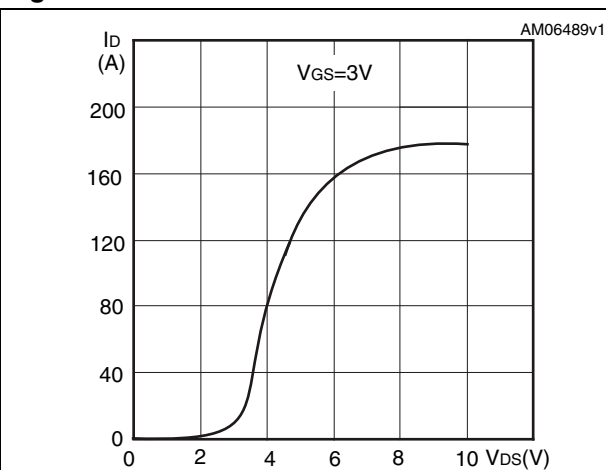


Figure 6. Normalized BV_{DSS} vs temperature

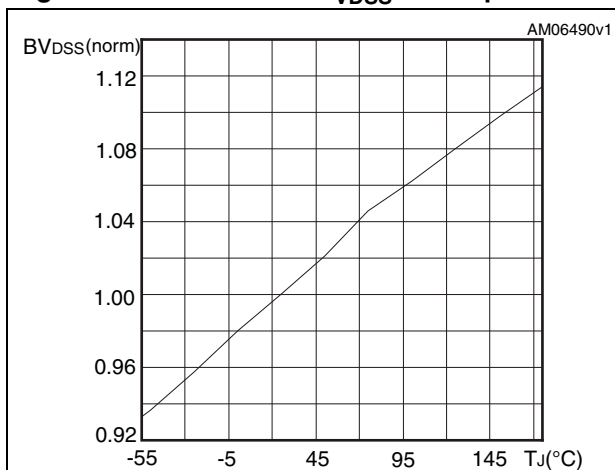


Figure 7. Static drain-source on-resistance

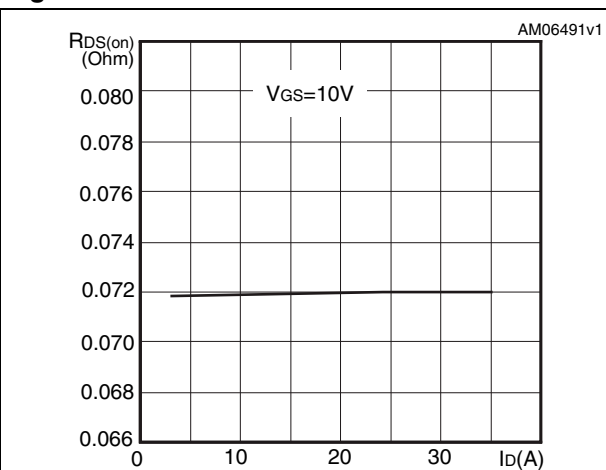


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

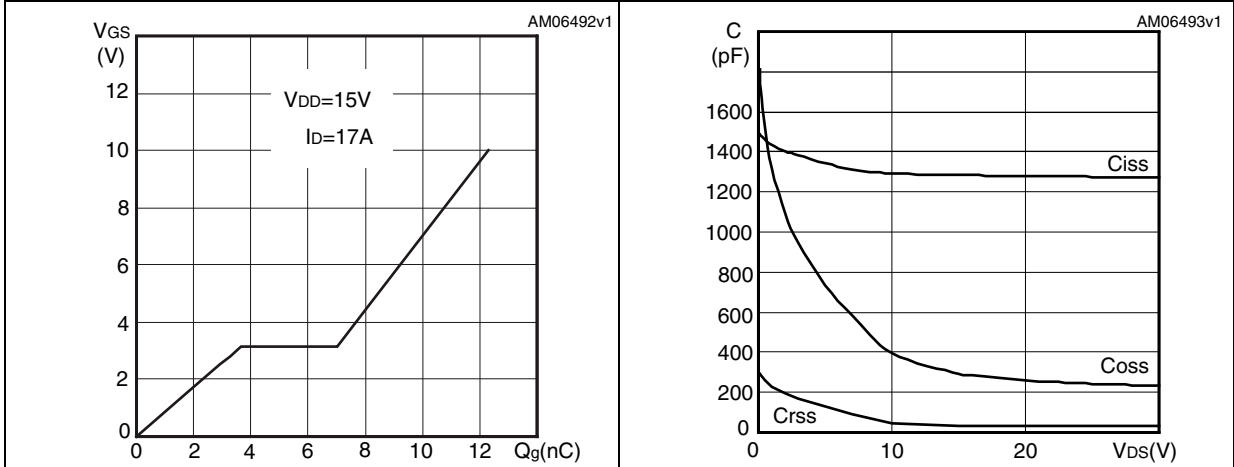


Figure 10. Normalized gate threshold voltage vs temperature Figure 11. Normalized on-resistance vs temperature

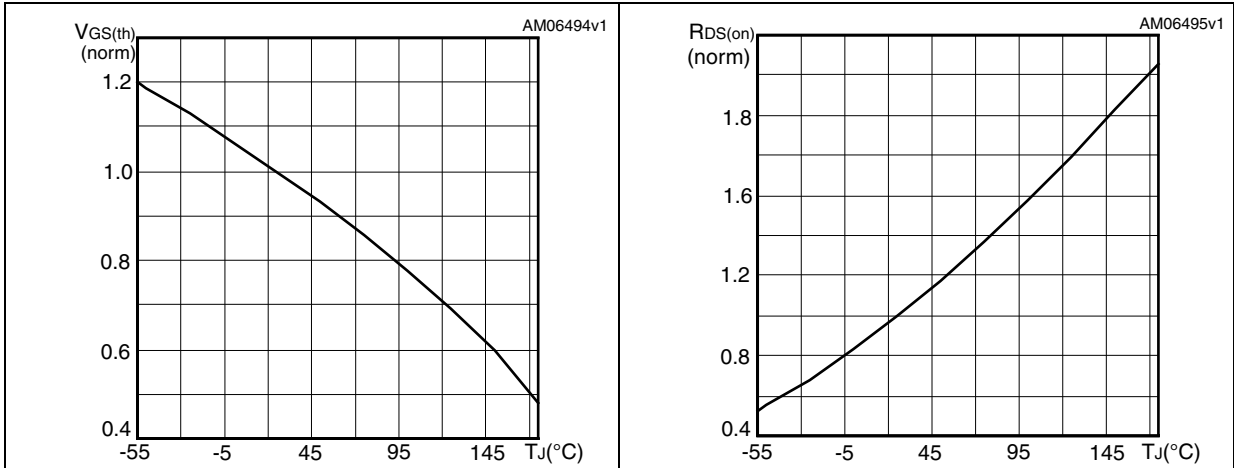
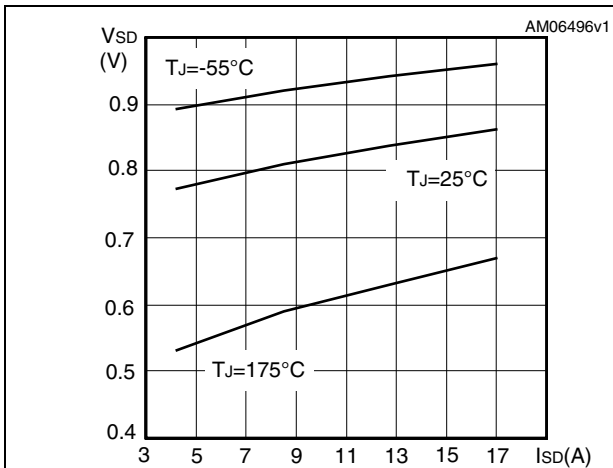


Figure 12. Source-drain diode forward characteristics



3 Test circuits

Figure 13. Switching times test circuit for resistive load



AM01468v1

Figure 14. Gate charge test circuit



AM01469v1

Figure 15. Test circuit for inductive load switching and diode recovery times



AM01470v1

Figure 16. Unclamped inductive load test circuit



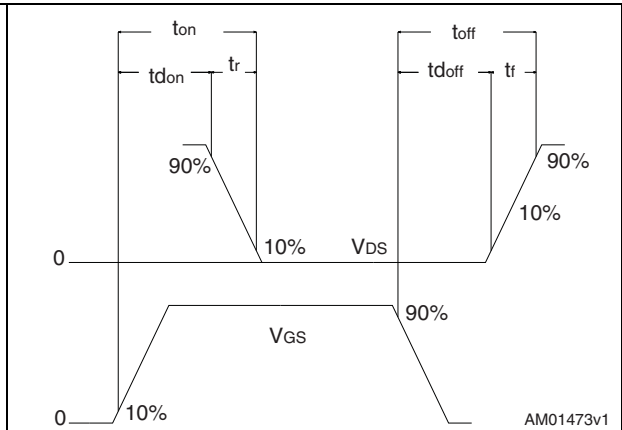
AM01471v1

Figure 17. Unclamped inductive waveform



AM01472v1

Figure 18. Switching time waveform



AM01473v1

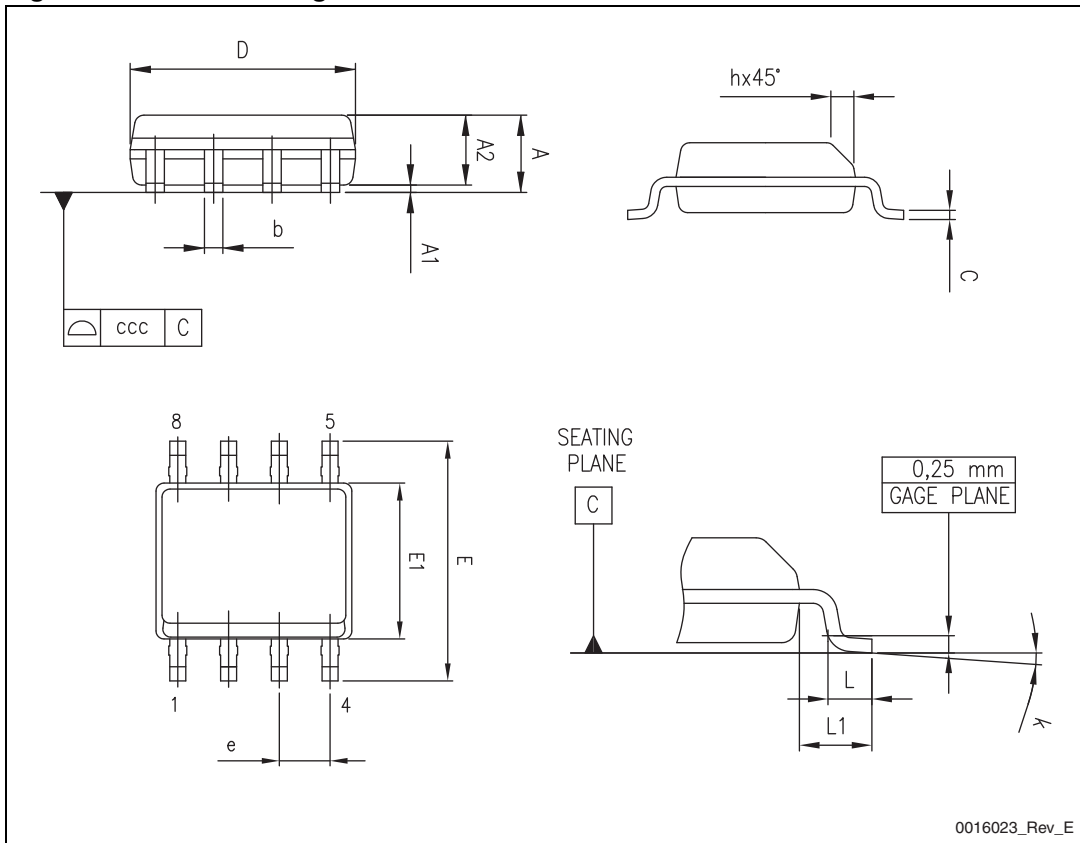
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. SO-8 mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.28		0.48
c	0.17		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
k	0°		8°
ccc			0.10

Figure 19. SO-8 drawing



5 Revision history

Table 9. Document revision history

Date	Revision	Changes
19-Feb-2010	1	First release.
01-Jul-2011	2	Datasheet status promoted from preliminary data to datasheet. Modified: Table 2 and 4 .
07-Jun-2012	3	Updated mechanical data. Minor text changes.

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